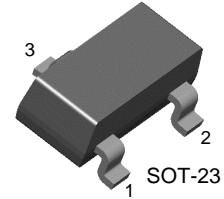


# MMBT3646

## Switching Transistor



1. Base 2. Emitter 3. Collector

### Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CEO}$	Collector-Emitter Voltage	15	V
$V_{CES}$	Collector-Emitter Voltage	40	V
$V_{CBO}$	Collector-Base Voltage	40	V
$V_{EBO}$	Emitter-Base Voltage	5	
$I_C$	Collector Current (DC) - Continuous	300	mA
$P_D$	Total Device Dissipation @ $T_A=25^\circ\text{C}$ - Derate above $25^\circ\text{C}$	625 5	mW mW/ $^\circ\text{C}$
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	150	$^\circ\text{C}$

### Electrical Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Units
<b>Off Characteristics</b>					
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage ( $I_C = 100\mu\text{Adc}$ , $V_{BE} = 0$ )	40			V
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage (1) ( $I_C = 10\text{mAdc}$ , $I_B = 0$ )	15			V
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage ( $I_C = 100\mu\text{Adc}$ , $I_E = 0$ )	40			V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage ( $I_E = 100\mu\text{Adc}$ , $I_C = 0$ )	5			V
$I_{CES}$	Collector Cut-off Current ( $V_{CE} = 20\text{Vdc}$ , $V_{BE} = 0$ ) ( $V_{CE} = 20\text{Vdc}$ , $V_{BE} = 0$ , $T_A = 65^\circ\text{C}$ )			0.5 3	$\mu\text{A}$
<b>On Characteristics (1)</b>					
$h_{FE}$	DC Current Gain ( $I_C = 30\text{mAdc}$ , $V_{CE} = 0.4\text{Vdc}$ ) ( $I_C = 100\text{mAdc}$ , $V_{CE} = 0.5\text{Vdc}$ ) ( $I_C = 300\text{mAdc}$ , $V_{CE} = 1\text{Vdc}$ )	30 25 15		120	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage ( $I_C = 30\text{mAdc}$ , $I_B = 3\text{mAdc}$ ) ( $I_C = 100\text{mAdc}$ , $I_B = 10\text{mAdc}$ ) ( $I_C = 300\text{mAdc}$ , $I_B = 30\text{mAdc}$ ) ( $I_C = 30\text{mA}$ , $I_B = 3\text{mA}$ , $T_A = 65^\circ\text{C}$ )			0.2 0.28 0.5 0.3	V
$V_{BE(sat)}$	Base-Emitter Saturation Voltage ( $I_C = 30\text{mAdc}$ , $I_B = 3\text{mAdc}$ ) ( $I_C = 100\text{mAdc}$ , $I_B = 10\text{mAdc}$ ) ( $I_C = 300\text{mAdc}$ , $I_B = 30\text{mAdc}$ )	0.73		0.95 1.2 1.7	V

**Electrical Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted) (Continued)

Symbol	Parameter	Min.	Typ.	Max.	Units
<b>Small-Signal Characteristics</b>					
$C_{obo}$	Output Capacitance ( $V_{CE} = 5\text{Vdc}$ , $I_E = 0$ , $f = 1\text{MHz}$ )			5	pF
$C_{ibo}$	Input Capacitance ( $V_{EB} = 0.5\text{Vdc}$ , $I_C = 0$ , $f = 1\text{MHz}$ )			8	pF
<b>Switching Characteristics</b>					
$t_{on}$	Turn-On Time	$V_{CC} = 10\text{Vdc}$ , $I_C = 300\text{mAdc}$ , $I_{B1} = 30\text{mAdc}$ , $V_{CE(off)} = 3\text{V}$		18	ns
$t_d$	Delay Time			10	ns
$t_r$	Rise Time			15	ns
$t_{off}$	Turn-Off Time	$V_{CC} = 10\text{Vdc}$ , $I_C = 300\text{mAdc}$ , $I_{B1} = I_{B2} = 30\text{mAdc}$		28	ns
$t_f$	Fall Time			15	ns
$t_s$	Storage Time			20	ns

**Thermal Characteristics**

Symbol	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient			200	$^\circ\text{C}$
$R_{\theta JC}$	Thermal Resistance, Junction to Case			83.3	$^\circ\text{C}$

# Package Dimensions

## SOT-23



Dimensions in Millimeters

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